

Feasibility of SSTDR for Identifying Electrochemical Signatures of Degradation

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WP3: Electrochemical Signatures of Degradation

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Outline

- Research background
- Reflectometry Sensors for Fault Location
- Future Milestone



Background

Objectives

- Identify electrochemical signals related to degradation using microscopic techniques
- Identify various properties relating to SoH, SoC using electrical techniques and correlate with the other work packages
- Transfer this knowledge from the cell to module and the stack
- Develop tools for analysing and managing large data (degradation signatures)
- Develop a concept of novel BMS that identify signals indicating degradation



Battery Diagnostics Methods





OEM Diagnostics Methods :Nissan Leaf





SoH Monitoring Using Reflectometry

- Time Domain Reflectometry TDR
- Frequency Domain Reflectometry FTDR
- Standing Wave Reflectometry SWR
- Mixed Signal Reflectometry MSR
- Coherent Optical Time Domain Reflectometry COTDR
- Sequence Time Domain Reflectometry STDR
- Spread Spectrum Time Domain Reflectometry SSTDR



SoH monitoring using TDR

TDR Basics – signal propagation

- Impedance discontinuity leads to reflection of travelling signal
- Pulse signal is driven into utilised cable, then travels down the line
- At impedance disruption $Z_L > Z_O$ a signal portion is reflected back
- Transmitted signal travels further, get reflected at the event exit $Z_F > Z_L$ and travels to the source
- At the cable end, the remaining signal is reflected back
- Cable properties and fault location easy to determine Reflection coefficient $\rho = V_{reflected}/V_{incident}$





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TDR on Coaxial Cable

- Various length of coaxial cable tested under open, splice and short circuit conditions
- Characteristic impedance of the cable easily determined
- The location of the fault or impedance discontinuity can be determined using propagation delay



Fig. 3a Pulse signal transmitted

Fig. 3 c $Z_F = Z_L$

(1 V/div)

(1µs/div)



Fig.3b Closed up of transmitted signal



 $Fig.\, 3d\,\, Short\,\, circuited$



TDR on coin cells

Voltage

variation

Damaged cell OCV: 1.000 V Scratched cell OCV: 2.874 V Overcharged cell OCV: 3.015 V Pristine cell OCV: 3.141 V

TDR Pulse width: 0.1 ms Frequency: 1 KHz Magnitude: 500 mV





TDR



Conclusion on TDR



- Higher energy in the signal
- Interference with other/ by other signals
- Narrow time
- Susceptible to noise

- Low energy in the signal time (PN code)
- Minimal or "NO" interference
- Broad Features allows it to be used in live aircraft wires
- Noise immunity



STDR/SSTDR



- Correlation tells time shift between two signals*
- Signals are so small below the allowable noise margin of any signal

*(shift signal in time, multiply them, integrate or add them)



Simulation



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S/SSTDR

Advantages

- Detect and locate faults on Dead or Live cables in "real time" 60- 400 Hz Ac, 5-270 V DC
- Precise fault location of +/-2 % on cables up to 3650 metres
- Monitor system integrity without impact on system operation
- Suitable for intermittent condition when the fault is present
- Many signals peacefully co exist (frequency band sharing (CDM)
- Immune to noise
- Multiple channel/paths
- Loss/attenuation
- Low interference/Jamming potential



Fig. 6b Multiple junctions [Furse et al]



Future Milestones

- Build a test rig to establish the suitability of S/SSTDR in identifying cell degradation signatures
- Correlate the findings with microscopic & spectroscopic techniques
- Correlate identified degradation signatures using SSTDR across work packages
- Transfer this knowledge from the cell to module and the stack
- Establish regular engagement with modelling fast-start to coordinate cell modelling and ReLIB for the development of non-invasive SoH techniques for re-use or recycling.
- IE:Spier New technologies on grading batteries and testing processes



Thanks for Listening

Q&A